

Implications of the Incremental Pulse and Verify Algorithm on the Forming and Switching Distributions in RERAM Arrays

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Abstract— In this work, the implication of the incremental pulse and verify (IPV) algorithm onto the Forming, Set and Reset read current distributions is studied in terms of inter-cell variability and reliability of 4kbit RERAM arrays with Ti/HfO₂/Ti/TiN stack. It is shown that the IPV algorithm causes an initial generalized Pareto distribution (GPD) for Forming, Set and Reset current. Due to read-induced fluctuations, the GPD evolves to a bimodal distribution for all cases. The separation value between the two distributions coincides with the threshold current of the IPV algorithm. The main problem arises from the minor distribution, which does not respect the algorithm stop condition. The percentage of the unwanted minor distribution is in the order of a few percentage points for Reset and lower than 1% for Set.

Index Terms—RERAM, inter-cell variability, Incremental Pulse and Verify, 4kbit array, generalized Pareto distribution.

I. INTRODUCTION

Resistive Random Access Memories (RERAM) is considered as one of the most promising nonvolatile memory technology due to its compatibility with CMOS processes, high-speed operations, low power consumption, and high scalability potential [1-4]. RERAM behavior is based on the possibility of electrically modifying the conductance of a Metal-Insulator-Metal (MIM) stack: Set operation moves the cell in a low resistive state (LRS), whereas Reset brings the cell in a high resistive state (HRS) [5], [6]. The resistance switching is ascribed to the formation/rupture of a conductive filament with a diameter lower than 10 nm [7], [8]. To activate such a switching behavior, some technologies require a preliminary Forming operation [9-11]. Although memory arrays integrating the one transistor – one resistor (1T-1R) cell

architecture demonstrated excellent performance parameters [12], [13], the inter-cell variability (variations between cells) and the intra-cell variability (cycle-to-cycle variations of any given cell) still prevent RERAM manufacturing from fast commercialization [14-17]. In memory arrays, where large cells subsets are considered, the statistical analysis of the switching parameters is required in order to understand and model the reliability and variability properties of the technology. In order to counteract the inter-cell variability, several algorithms have been proposed [18-22]. In particular, the Incremental Pulse and Verify (IPV) algorithm allows to bring the cells into an electrically comparable state during Forming, Set and Reset operations. In case of Pulse and DC sweep operations the modeling of the read current distributions, which mainly depends on the switching properties of the conductive filament, has been deeply investigated in literature [23-26]. Deora *et al.* [26] reported that the HfO₂ based RRAM devices exhibit normal distribution in the LRS and lognormal distribution in the HRS. However, when the IPV algorithm is considered also the selected Forming, Set and Reset thresholds and the read current fluctuations play a role into the final measured current distributions: in this case, a deep understanding and a statistical modeling of the switching parameters and read current distributions still lacks.

In this work, the Forming, Set and Reset current distributions obtained with the IPV algorithm are studied and modeled, in order to analyze the impact of this algorithm on the inter-cell variability and reliability of 4kbit RERAM arrays. Moreover, the impact of the read-induced fluctuations onto the Forming and switching distributions is investigated.

II. EXPERIMENTAL SETUP

The 4kbit array is composed by four architectural blocks, as depicted in Fig. 1: the 1T-1R RRAM cells matrix, a wordline (WL) address decoder, a bitline (BL) address decoder, and the operation control circuitry. The 1T-1R memory cells in the array are constituted by a select NMOS transistor manufactured with a 0.25 μm BiCMOS technology whose drain is in series to a MIM stack. The current compliance is defined through the WL voltage, which allows setting the gate voltage of the NMOS transistor. The cross-sectional Scanning Transmission Electron Microscopy (STEM) image of a 1T-1R cell and the cell schematic are

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reported in Fig. 2. The variable MIM resistor is composed by 150 nm TiN top and bottom electrode layers deposited by

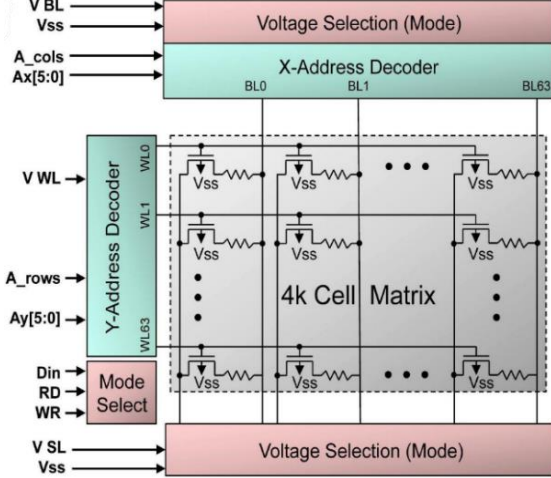


Fig. 1. Block diagram of the memory array.

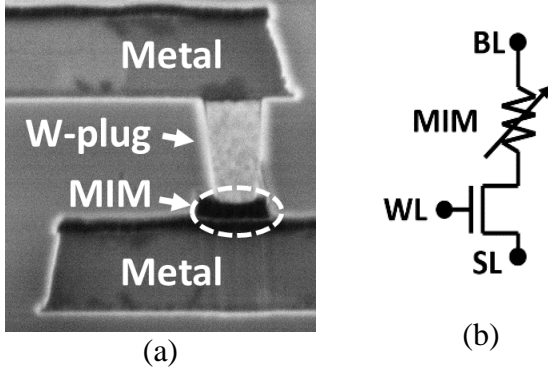


Fig. 2. Cross-sectional STEM image (a) and schematic (b) of the 1T-1R cell integrated in the arrays.

magnetron sputtering, a 7 nm Ti layer, and 8 nm HfO₂ layer deposited with an Atomic Vapour Deposition (AVD) process resulting into a polycrystalline HfO₂ film. The resistor area is equal to 0.4 μm². The Forming/Set/Reset operations on the arrays were performed by using an IPV algorithm, as sketched in Fig. 3. The sourceline (SL), BL and WL voltages applied during Forming, Set, Reset and Read operations are reported in Table I. Reset operations were performed by applying the highest WL voltage available ($V_{WL}=2.8$ V) to maximize the cell switching yield while avoiding the breakdown of the MIM [1]. Pulses were applied during Forming by increasing V_{BL} with $\Delta V_{BL}=0.01$ V, whereas during Set and Reset $\Delta V_{BL}=0.1$ V and $\Delta V_{SL}=0.1$ V have been used, respectively. Forming was done with smaller step compared to Set/Reset in order to have the highest cell-to-cell uniformity after Forming. However, using such step in Set/Reset would drastically increase the cycling time, hence a larger step was used on Set/Reset. Each pulse featured a duration of 10μs, with a rise/fall time of 1μs to avoid overshoot issues. Forming and Set operation were stopped on a cell when the read-verify current reached a value higher than 20μA, whereas Reset was stopped when a value lower than 10μA was reached. The measurement system continued to read all the cells until all the cells reached the stop condition. In other words, for each cycle, the cells which

didn't reach the stop condition were pulsed and read, while the cells which reached the stop condition were only read.

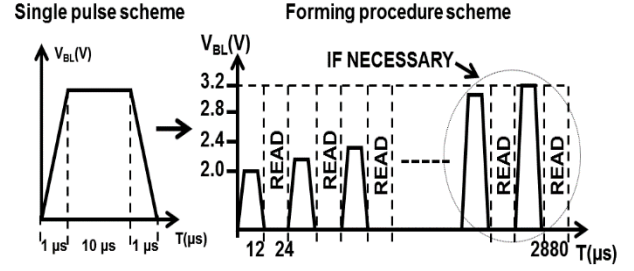


Fig. 3. IPV algorithm scheme.

TABLE I
FORMING, SET, RESET AND READ PARAMETERS

Operation	V_{SL} [V]	V_{BL} [V]	V_{WL} [V]
Forming	0	2→3.2	1.5
Set	0	0.2→3.2	1.5
Reset	0.2→3.2	0	2.8
Read	0	0.2	1.5

III. RESULTS AND DISCUSSION

Fig. 4(a) and (b) show the histogram of the Forming voltage and the corresponding cumulative distribution function (cdf) in a normal probit scale, respectively. Since the algorithm starts from 2 V, values of Forming voltage lower than 2 V are cumulated in the first bin of the histogram. Unless the first bin, the histogram exhibits a normal shape. The normal distribution in the explored voltage interval, ranging from 2V to 3.2 V, is clearly confirmed by the linear behavior observed in Fig. 4(b).

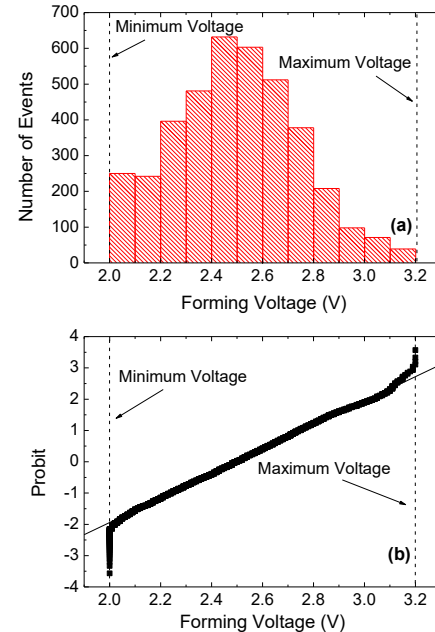


Fig. 4. Histogram of the forming voltage (a) and the corresponding cdf (b) in a normal probit scale. A normal distribution is observed in the explored voltage range.

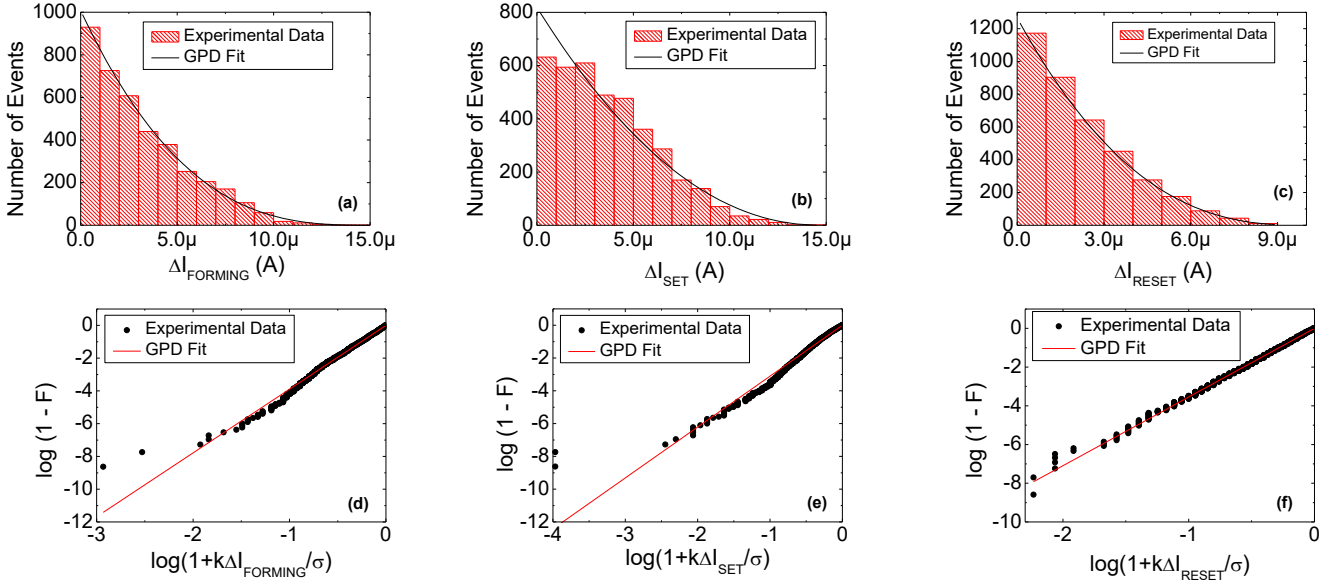


Fig 5. Histogram of the initial distribution of the Forming (a), Set (b), Reset (c) current shift and the corresponding cumulative distribution function (d,e,f). The observed linear behaviors of the cdf confirm that the three initial distributions follow a GPD.

Two distributions for the Forming, Set and Reset current were analyzed. The initial distribution was obtained by considering the values of the current exactly when the stop condition was reached. The final distribution was obtained by considering the values of the current at the end of the programming procedure. Therefore, in the case of the final distribution, almost all the cells were read several times after the stop condition was reached. As it will be shown in the following, the final distribution is significantly different from the initial distribution due to read-induced fluctuations.

In the case of the initial distribution, we considered the shift between the measured current and the threshold current of the IPV algorithm, as follows

$$\Delta I_{FORMING} = I_{FORMING} - I_{TH}(FORMING) \quad (1)$$

$$\Delta I_{SET} = I_{SET} - I_{TH}(SET) \quad (2)$$

$$\Delta I_{RESET} = I_{TH}(RESET) - I_{RESET} \quad (3)$$

where $I_{TH}(FORMING)=I_{TH}(SET)=20\mu A$, $I_{TH}(RESET)=10\mu A$. As shown in Fig.5, the initial distributions of the Forming, Set and Reset current shift exhibit a monotonic decreasing behavior, which is well fitted by a generalized Pareto distribution (GPD). It is worth noting that the simple exponential distribution fails to fit the experimental data (see Fig. 6).

The probability density function (pdf) and the cdf of the GPD, with shape parameter $k \neq 0$, scale parameter σ , and threshold parameter θ , are given respectively by

$$f = \frac{1}{\sigma} \left(1 + k \frac{x-\theta}{\sigma}\right)^{-1-\frac{1}{k}} \quad (4)$$

$$F = 1 - \left(1 + k \frac{x-\theta}{\sigma}\right)^{-\frac{1}{k}} \quad (5)$$

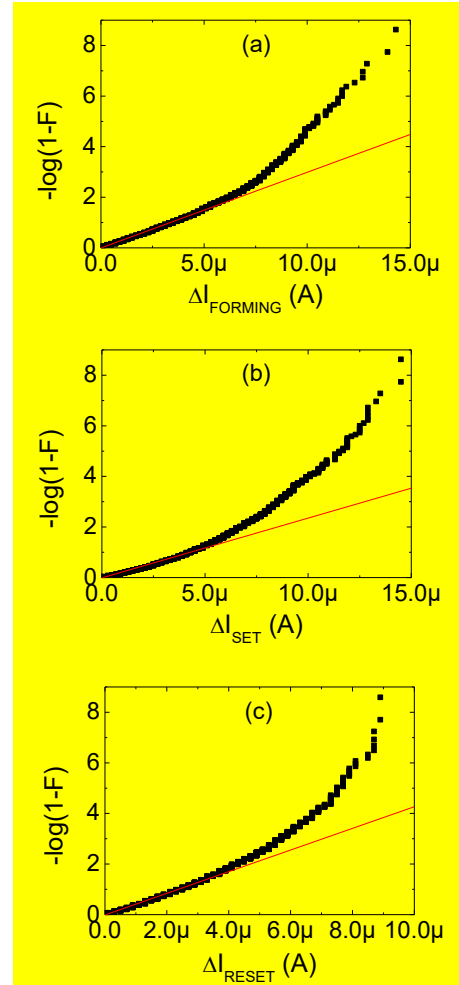


Fig. 6. The initial distribution of the Forming (a), Set (b), Reset (c) current shift do not follow an exponential distribution, as highlighted by the deviation of experimental data (symbols) by the linear behavior (red line).

for $x > \theta$, when $k > 0$, or for $\theta < x < -\sigma/k$, when $k < 0$. The first two moments are related to the three GPD parameters (k , σ , θ) by the following equations

$$\text{mean} = \theta + \frac{\sigma}{1-k} \quad k < 1$$

$$\text{variance} = \frac{\sigma^2}{(1-k)^2(1-2k)} \quad k < 1/2$$

Obviously, since we considered current shift values as defined by (1)-(3), the threshold parameter θ is equal to 0 in all cases. By using the maximum likelihood estimation method, we obtain values for the shape parameter k equal to -0.257 (Set), -0.322 (Set) and -0.282 (Reset), and values for the scale parameter equal to 3.88 μA (Forming), 4.76 μA (Set) and 2.81 μA (Reset).

Fig. 7 shows an example of read variability of Forming current measured after the stop condition was reached. We observe that some values of the read current are lower than the threshold current of the IPV algorithm. Similar problems of read instability have been observed also for Set and Reset current (not shown). Read variability has been ascribed to numerous physical mechanisms such as disturbs induced by the read electric field, capture and emission of trapped electrons, and diffusion of traps or vacancies [27].

Due to read variability, the GPD evolves to a bimodal distribution for all cases (see Fig. 8). The cdf exhibits a dual slope linear behavior in the lognormal probit scale for Forming and Set and in the normal probit scale for Reset. The separation between the major and the minor distribution is highlighted by the change of slope. As expected, the separation value corresponds to the threshold current of the IPV algorithm: 20 μA for Forming and Set and 10 μA for Reset.

Tables II-IV compare the basic statistical parameters (mean, standard deviation and their ratio, referred as coefficient of

variation) for the initial and the final distribution of Forming, Set and Reset, respectively. In the case of the final distribution, the statistical parameters for the major and the minor distribution are also reported. The main difference between the initial and the final distribution is clearly the appearance of the unwanted minor distribution, which does not respect the algorithm stop condition. The percentage of the minor distribution is in the order of a few percentage points for Forming and Reset and lower than 1% for Set. In other words, the use of different thresholds for Set and Reset in the IPV algorithm does not guarantee the absence of overlap between the two populations, due to fluctuations induced by the readings occurring after the cell programming. On the one hand, the mean value of the final distribution for Set and Reset is better respect to the initial distribution, since it is higher for Set and lower for Reset. On the other hand, the standard deviation and the coefficient of variation of the final distribution for Set and Reset are worst (higher) respect to the initial distribution.

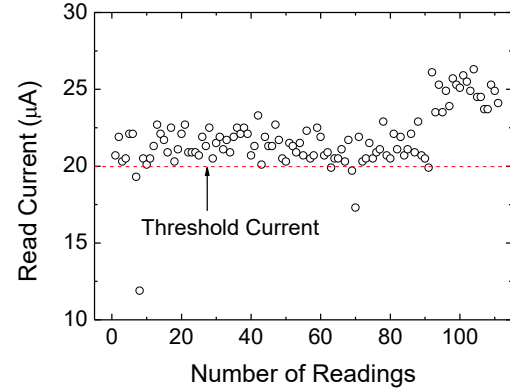


Fig. 7. Read variability of Forming current after the stop condition was reached.

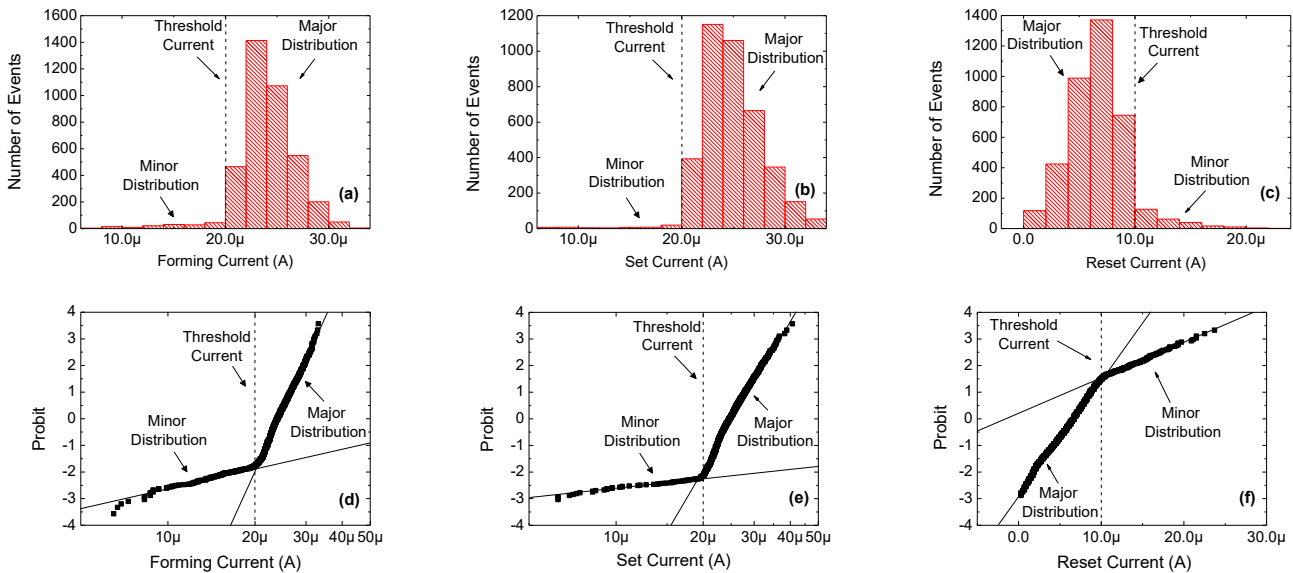


Fig 8. Histogram of the final distribution of the Forming (a), Set (b), Reset (c) current and the corresponding cumulative distribution function (d,e,f). A clear bimodal distribution is observed in all cases.

TABLE II
STATISTICAL PARAMETERS FOR FORMING

	Initial	Final	Final Major (96.08%)	Final Minor (3.92%)
Mean (μA)	23.1	23.9	24.3	14.7
Standard deviation (μA)	2.51	3.13	2.19	3.84
Coefficient of variation (adim.)	0.11	0.13	0.09	0.26

TABLE III
STATISTICAL PARAMETERS FOR SET

	Initial	Final	Final Major (99.46%)	Final Minor (0.54%)
Mean (μA)	23.6	24.9	25.1	13.6
Standard deviation (μA)	2.89	3.24	2.82	5.26
Coefficient of variation (adim.)	0.12	0.13	0.11	0.39

TABLE IV
STATISTICAL PARAMETERS FOR RESET

	Initial	Final	Final Major (94.31%)	Final Minor (5.69%)
Mean (μA)	7.54	6.69	6.24	12.9
Standard deviation (μA)	2.23	2.66	2.00	2.77
Coefficient of variation (adim.)	0.30	0.4	0.32	0.22

IV. CONCLUSIONS

In this paper, we have analyzed the implications of the incremental pulse and verify (IPV) algorithm on the Forming and switching distributions of 4kbit RRAM arrays with Ti/HfO₂/Ti/TiN stack.

It is shown that the IPV algorithm causes an initial generalized Pareto distribution (GPD) for Forming, Set and Reset current. The threshold current fixed by the IPV algorithm coincides with the GPD threshold parameter. This value is the maximum probability point of the pdf, which exhibits a monotonic decrease for higher (lower) values in the case of Forming and Set (Reset).

Due to read-induced fluctuations, the GPD evolves to a bimodal distribution for all cases. The separation value between the two distributions coincides with the threshold current of the IPV algorithm. The main difference between the initial and the final distribution is the appearance of the unwanted minor distribution, which does not respect the algorithm stop condition. The percentage of the minor distribution is in the order of a few percentage points for Reset and an order of magnitude lower for Set. Moreover, the final distribution exhibits higher values of standard deviation and coefficient of variation for all cases. This experimental study points out that the initial control of the LRS and HRS obtained

by the IPV algorithm is significantly degraded by successive reading-induced fluctuations.

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